How do I reduce the etch rate? Do I need to dilute the etchant? How do I reduce undercutting? Appearance pН Etch Rate at 40 oC Etch Capacity (rate declines at ~70%) Shelf Life Storage Conditions Filtration **Recommended Operating Temperatures** Rinse **Photoresist Recommendations** Select Compatible Materials Select Incompatible Materials **Compatible Plastics** Country of Origin Availability **Available Sizes** Packaging Packing Isotropy **Incompatible Chemicals** Additional Information

How do I increase the etch rate?

1. The rate will approximately double with every 10 oC increase in temperature.

2. Increase the rate of stirring or agitation.

Adding 1 part deionized water to 2 parts etchant will reduce the etch rate approximately 50%.

No, it is ready to use.

Increase the rate of stirring or agitation.

Light yellow Strong acid 50 Å/second 100 g/gallon 1 year Avoid freezing 1 mm 20-80 oC (30-40 oC most common) Deionized water KLT6000 Series, KLT 5300 Series, HARE SQT (SU-8 type), TRANSIST, or PKP Type II http://transene.com/semi/#pho GaAs, Au, Cu (most applications), glass, alumina, nitride. See http://transene.com/etch-compatibility/ for more du Al, Ag HDPE, PP, Teflon, PFA, PVC USA 1-2 days Quart, Gallon, 5 Gallon, 55 Gallon HDPE 4 gallons/case Isotropic Strong bases Suitable for electroless or electrolytic nickel

to etails.